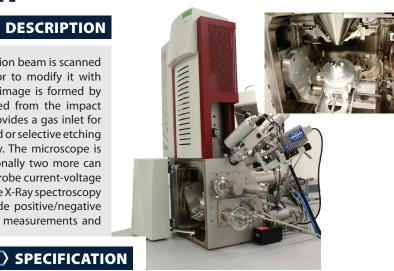
# **Scanning Electron Microscope with Focused Ion Beam**

#### FIB-SEM TESCAN LYRA3

## **DESCRIPTION**

SEM/FIB is a type of microscope where a focused electron/ion beam is scanned over the sample to generate an image of the surface or to modify it with nanometric resolution (usually better than 10 nm). The image is formed by detecting secondary and backscattered electrons emitted from the impact place of particle beam. The Gas Injection System (GIS) provides a gas inlet for gaseous precursors, thus allowing deposition and enhanced or selective etching on the sample surface using advanced surface chemistry. The microscope is equipped with two closed loop nanomanipulators (optionally two more can be installed), which allows measurement of 2-probe or 4-probe current-voltage characteristics. The tool is equipped with Electron Dispersive X-Ray spectroscopy analyser (EDX) for elemental analysis. Applications include positive/negative lithography, sample imaging and modification, electrical measurements and basic chemical and elemental analysis.



## **RESULTS**



Resitivity 1.7×10² Ωm of the nanowire with the parameters: Length ~30 μm Width 1150 nm Thickness 55 nm (The image on the left)

Manipulation with an amorphized silicon nanowire by a nanomanipulator tip and its

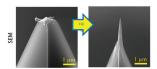
nanomanipulators and gold contacts on Si/SiO<sub>2</sub> substrate. (Image courtesy of





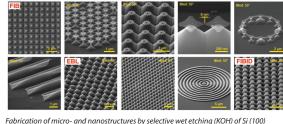


Focused Electron Beam Induced Deposition (FEBID) of Magnetic Nanostructures by using Dicobalt octacarbonyl Co<sub>2</sub>(CO)<sub>8</sub> precursor characterized by AFM (Atomic Force Microscope) and MFM (Magnetic Force Microscope). (Image courtesy of Michal Urbanek)



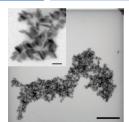


SSEM: Repair of a Si AFM probe tip with high level damage by local ion milling. (Image courtesy of Tomas Samoril)



with FIB, EBL or FIBID mask. (Image courtesy of Tomas Samoril)

Decontaminator/Plasma Cleaner



**Energy Resolution** 

TEM lamella preparation. (Image

#### **Product name** LYRA 3 XMH Ion Column Canion **Emitter** Schottky cathode **Emitter** Ga LMIS 200 V-30 kV/50 V-30kV in Acceleration Acceleration 500 V-30 kV Beam Deceleration Mode (BDM) Voltage Voltage **Probe Current** 2 pA-200 nA **Probe Current** 1 pA-40 nA SE/ 1.2 nm @ 30kV SEM - FIB WD 9 mm (SEM) / 2.5 nm @ 3kV Coincidence at WD 12 mm (FIB) SE (BDM) / 1.5 nm @ 3kV SEM - FIB Angle at 55° Detectors/ In Beam BSE / 2.0 nm @ 15kV Resolution BSE / 2.0 nm @ 30kV **Number of Channels** ΤE **Type of Precursors** SiO<sub>2</sub>, H<sub>2</sub>O, F, PT, W, (Co) **Nanomanipulators Chamber Vacuum** < 9e<sup>-3</sup> Pa (<5e<sup>-4</sup> Pa reachable) Smaract (closed loop) Type Compucentric, fully motorized 2 at chamber roof Position X: 130 mm (-65 mm to +65 mm) 2 optional at SEM stage Y: 130 mm (-65 mm to +65 mm) Analytical (EDX) detector Specimen Stage Movements BRUKER XFlash 5010 7: 100 mm Type

FIB

Characterization of CuO/ZnO nanocomposite by transmitted electron (TE) detector in bright field. (Image courtesy of Jan Cechal)

< 129 eV @ MnKa

59 eV @ FKa

52 eV @ CKα



> MORE INFO

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Rotation: 360° continuous

Tilt: -30° to +90° mm

